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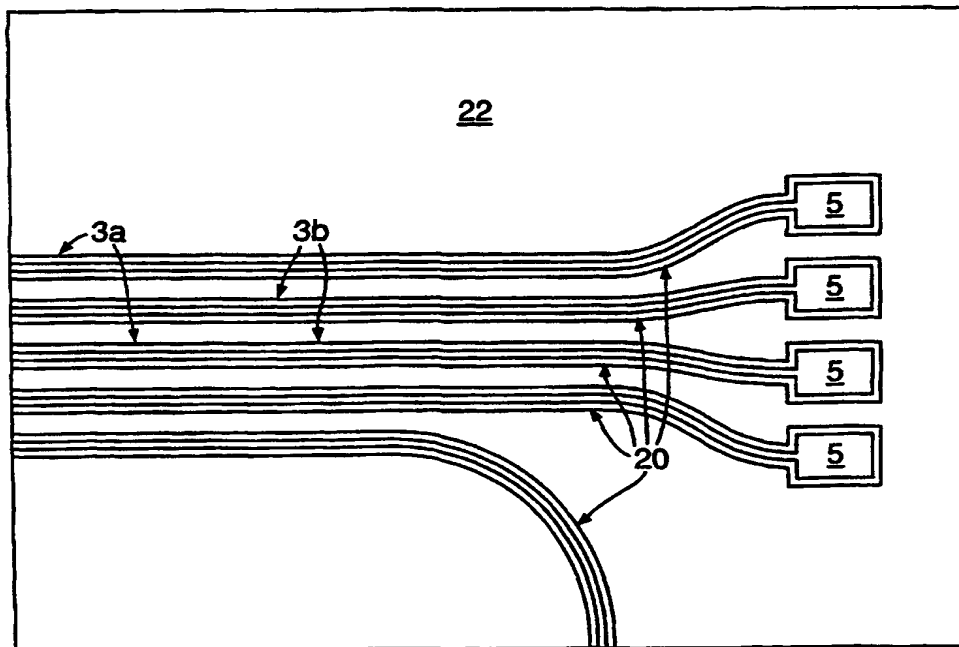
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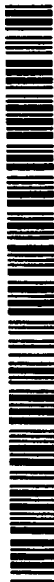
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- (75) Inventor/Applicant (*for US only*): BAND, Cyril, William [GB/GB]; The Paddock, 83 High Street, Finstock, Chipping Norton, Oxon OX7 3DA (GB). For two-letter codes and other abbreviations, refer to the "Guidance Notes on Codes and Abbreviations" appearing at the beginning of each regular issue of the PCT Gazette.

(54) Title: PRINTED CIRCUIT FABRICATION



(57) Abstract: A mask for producing a printed circuit board is defined in which the conductor elements of the printed circuit pattern are delineated by a constant width etch band (20). This means that all conductors (3a, 3b, 9) are separated from neighbouring areas of conductive material (22) by the same distance. Thus etch rates across the printed circuit pattern do not vary according to the separation of the conductors (3a, 3b, 9).

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